imall

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BoHS

COMPLIANT

Standard Thick Film Chip Resistors



FEATURES

- Stability $\Delta R/R = 1$ % for 1000 h at 70 ° C
- 2 mm pitch packaging option for 0603 size
- Pure tin solder contacts on Ni barrier layer HALOGEN provides compatibility with lead (Pb)-free and lead containing soldering processes
- Metal glaze on high quality ceramic
- AEC-Q200 qualified
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

| STANDARD ELECTRICAL SPECIFICATIONS | | | | | | | | | | | | |
|------------------------------------|------|----------|--|---|---|------------------------------|--------------------------|-----------------|-----------------|------------|------------|-----------------|
| MODEL | SIZE | | RATED DISSIPATION ₽ _{70 °C} W | LIMITING ELEMENT VOLTAGE U _{max.} AC/DC | TEMPERATURE COEFFICIENT ppm/K | TOLERANCE % | RESISTANCE RANGE Ω | SERIES | | | | |
| D10/CRCW0402 | 0402 | RR 1005M | 0.063 | 50 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | | | |
| | | | Zero-Ohm-Resistor: | $R_{\rm max.} = 20 \ {\rm m}\Omega$ | e, <i>I</i> _{max.} at 70 °C = 1. | 5 A | | | | | | |
| D11/CRCW0603 | 0603 | RR 1608M | 0.10 | 75 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | | | |
| | | | Zero-Ohm-Resistor: | $R_{\text{max.}} = 20 \text{ m}\Omega$ | , <i>I</i> _{max.} at 70 °C = 2. | D A | | | | | | |
| D12/CRCW0805 | 0805 | 0805 | 0805 | 0805 | 0805 | RR 2012M | 0.125 | 150 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 |
| | | | Zero-Ohm-Resistor: $R_{max.} = 20 \text{ m}\Omega$, $I_{max.}$ at 70 °C = 2.5 A | | | | | | | | | |
| D25/CRCW1206 | 1206 | RR 3216M | 0.25 | 200 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | | | |
| | | | Zero-Ohm-Resistor: R_{max} = 20 mΩ, I_{max} at 70 °C = 3.5 A | | | | | | | | | |
| CRCW1210 | 1210 | 1210 | RR 3225M | 0.5 | 200 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | | |
| | | | Zero-Ohm-Resistor: $R_{max.}$ = 20 mΩ, $I_{max.}$ at 70 °C = 5.0 A | | | | | | | | | |
| CRCW1218 | 1218 | RR 3246M | 1.0 | 200 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 2M2 | E24; E96 E24 | | | | |
| | | | Zero-Ohm-Resistor: $R_{\text{max.}}$ = 20 mΩ, $I_{\text{max.}}$ at 70 °C = 7.0 A | | | | | | | | | |
| CRCW2010 | 2010 | 2010 | 2010 | 2010 | 2010 | RR 5025M | 0.75 | 400 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 |
| | | | Zero-Ohm-Resistor: $R_{max.}$ = 20 mΩ, $I_{max.}$ at 70 °C = 6.0 A | | | | | | | | | |
| CRCW2512 | 2512 | RR 6332M | 1.0 | 500 | ± 100 ± 200 | ± 1 ± 5 | 1R0 to 10M | E24; E96 E24 | | | | |
| | | | | Zero-Ohm-Resistor: | $R_{\text{max.}} = 20 \text{ m}\Omega$ | $I_{\rm max.}$ at 70 °C = 7. | D A | | | | | |

Notes

• These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.

• Marking: See data sheet "Surface Mount Resistor Marking" (document number 20020).

• Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.

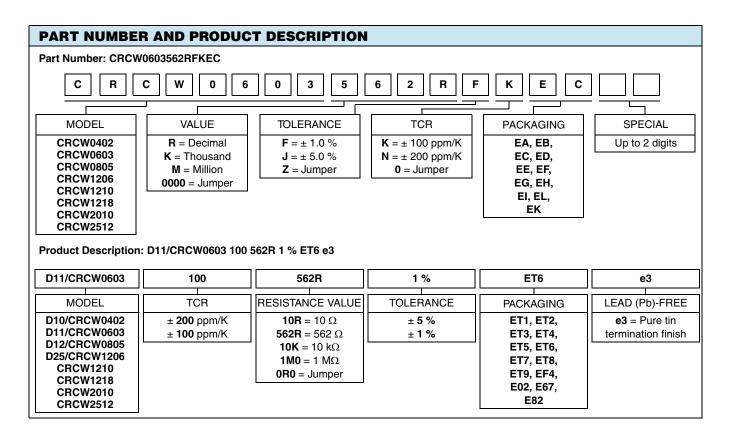
Standard Thick Film Chip Resistors



| TECHNICAL SPECIFICATIONS | | | | | | | | | |
|---|------|-------------------|------------------|------------------|---------------------|----------|----------|----------|----------|
| PARAMETER | UNIT | D10/ CRCW0402 | D11/ CRCW0603 | D12/ CRCW0805 | D25/ CRCW1206 | CRCW1210 | CRCW1218 | CRCW2010 | CRCW2512 |
| Rated dissipation $P_{70}^{(1)}$ | w | 0.063 | 0.1 | 0.125 | 0.25 | 0.5 | 1.0 | 0.75 | 1.0 |
| Limiting element voltage U _{max.} AC/DC | v | 50 | 75 | 150 | 200 | 200 | 200 | 400 | 500 |
| Insulation voltage <i>U</i> _{ins} (1 min) | v | > 75 | > 100 | > 200 | > 300 | > 300 | > 300 | > 300 | > 300 |
| Insulation resistance | Ω | > 10 ⁹ | | | | | | | |
| Category temperature range | °C | - 55 to + 155 | | | | | | | |
| Failure rate h ⁻¹ | | | | < 0.1 | x 10 ^{- 9} | | | | |
| Weight | mg | 0.65 | 2 | 5.5 | 10 | 16 | 29.5 | 25.5 | 40.5 |

Note

⁽¹⁾ The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.



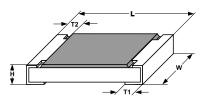


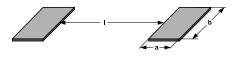
Standard Thick Film Chip Resistors

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| PACKAGING | | | | | | | | |
|-----------|----------|----------|-----------------------------------|---------|---------|---------------|--|--|
| MODEL | CODE | QUANTITY | CARRIER TAPE | WIDTH | PITCH | REEL DIAMETER | | |
| CRCW0402 | ED = ET7 | 10 000 | | 8 mm | 2 mm | 180 mm/7" | | |
| 000402 | EE = EF4 | 50 000 | | | | 330 mm/13" | | |
| | EI = ET2 | 5000 | | | | 180 mm/7" | | |
| | ED = ET3 | 10 000 | | 8 mm | 2 mm | 180 mm/7" | | |
| | EL = ET4 | 20 000 | | 0 11111 | 2 11111 | 285 mm/11.25" | | |
| CRCW0603 | EE = ET8 | 50 000 | | | | 330 mm/13" | | |
| | EA = ET1 | 5000 | | 8 mm | | 180 mm/7" | | |
| | EB = ET5 | 10 000 | | | 4 mm | 285 mm/11.25" | | |
| | EC = ET6 | 20 000 | Paper tape acc. to IEC 60068-3 | | | 330 mm/13" | | |
| | EA = ET1 | 5000 | Type I | 8 mm | 4 mm | 180 mm/7" | | |
| CRCW0805 | EB = ET5 | 10 000 | iypor | | | 285 mm/11.25" | | |
| | EC = ET6 | 20 000 | | | | 330 mm/13" | | |
| | EA = ET1 | 5000 | | 8 mm | 4 mm | 180 mm/7" | | |
| CRCW1206 | EB = ET5 | 10 000 | | | | 285 mm/11.25" | | |
| | EC = ET6 | 20 000 | | | | 330 mm/13" | | |
| | EA = ET1 | 5000 | | | | 180 mm/7" | | |
| CRCW1210 | EB = ET5 | 10 000 | | 8 mm | 4 mm | 285 mm/11.25" | | |
| | EC = ET6 | 20 000 | | | | 330 mm/13" | | |
| CRCW1218 | EK = ET9 | 4000 | | 12 mm | 4 mm | 180 mm/7" | | |
| CRCW2010 | EF = E02 | 4000 | Blister tape acc. | 12 mm | 4 mm | 180 mm/7" | | |
| | EG = E67 | 2000 | to IEC 60068-3 Type II | 10 mm | 8 mm | 100 mm/7" | | |
| CRCW2512 | EH = E82 | 4000 | 1,50 | 12 mm | 4 mm | 180 mm/7" | | |

DIMENSIONS



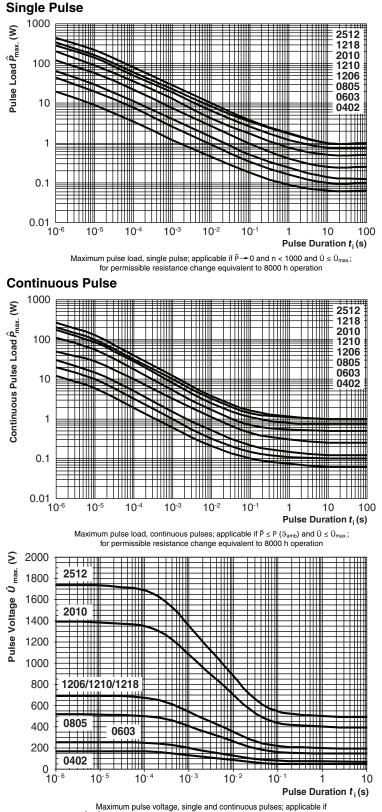


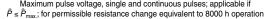
| | IZE | DIMENSIONS in millimeters | | | | | SOLDER PAD DIMENSIONS in millimeters | | | | | | |
|------|--------|----------------------------------|----------------|-----------------|----------------------|---------------|--------------------------------------|------------------|-----|------|----------------|-----|--|
| | | | | | | | | REFLOW SOLDERING | | | WAVE SOLDERING | | |
| INCH | METRIC | L | w | Н | T1 | T2 | а | b | I | а | b | I | |
| 0402 | 1005 | 1.0 ± 0.05 | 0.5 ± 0.05 | 0.35 ± 0.05 | 0.25 ± 0.05 | 0.2 ± 0.1 | 0.4 | 0.6 | 0.5 | | | | |
| 0603 | 1608 | 1.55 ^{+ 0.10} - 0.05 | 0.85 ± 0.1 | 0.45 ± 0.05 | 0.3 ± 0.2 | 0.3 ± 0.2 | 0.5 | 0.9 | 1.0 | 0.9 | 0.9 | 1.0 | |
| 0805 | 2012 | 2.0 + 0.20 - 0.10 | 1.25 ± 0.15 | 0.45 ± 0.05 | 0.3 + 0.20 - 0.10 | 0.3 ± 0.2 | 0.7 | 1.3 | 1.2 | 0.9 | 1.3 | 1.3 | |
| 1206 | 3216 | 3.2 + 0.10 | 1.6 ± 0.15 | 0.55 ± 0.05 | 0.45 ± 0.2 | 0.4 ± 0.2 | 0.9 | 1.7 | 2.0 | 1.1 | 1.7 | 2.3 | |
| 1210 | 3225 | 3.2 ± 0.2 | 2.5 ± 0.2 | 0.55 ± 0.05 | 0.45 ± 0.2 | 0.4 ± 0.2 | 0.9 | 2.5 | 2.0 | 1.1 | 2.5 | 2.2 | |
| 1218 | 3246 | 3.2 + 0.10 | 4.6 ± 0.15 | 0.55 ± 0.05 | 0.45 ± 0.2 | 0.4 ± 0.2 | 1.05 | 4.9 | 1.9 | 1.25 | 4.8 | 1.9 | |
| 2010 | 5025 | 5.0 ± 0.15 | 2.5 ± 0.15 | 0.6 ± 0.1 | 0.6 ± 0.2 | 0.6 ± 0.2 | 1.0 | 2.5 | 3.9 | 1.2 | 2.5 | 3.9 | |
| 2512 | 6332 | 6.3 ± 0.2 | 3.15 ± 0.15 | 0.6 ± 0.1 | 0.6 ± 0.2 | 0.6 ± 0.2 | 1.0 | 3.2 | 5.2 | 1.2 | 3.2 | 5.2 | |

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FUNCTIONAL PERFORMANCE





For technical questions, contact: thickfilmchip@vishay.com

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Standard Thick Film Chip Resistors

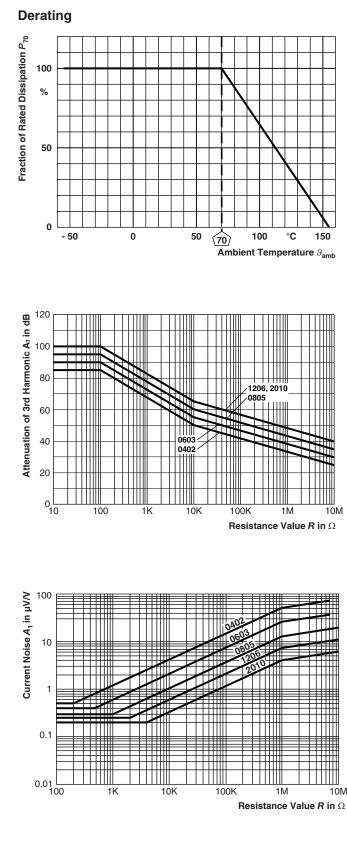
150

10M

10M

D/CRCW e3

Vishay



Standard Thick Film Chip Resistors



| TEST I | PROCED | URES AND REC | UIREMENTS | | | | | |
|---------------|-----------------------|-----------------------------|--|---|--|--|--|--|
| IEC | | | | REQUIREMENTS PERMISSIBLE CHANGE (\(\triangle R)\) | | | | |
| EN 60115-1 | 60068-2 | TEST | PROCEDURE | SIZE 0402 | to 2512 | | | |
| CLAUSE | TEST METHOD | | | STABILITY CLASS 1 OR BETTER | STABILITY CLASS 2 OR BETTER | | | |
| | | | Stability for product types: | | | | | |
| | | | D/CRCW e3 | 1 Ω to 1 | 0 ΜΩ | | | |
| 4.5 | - | Resistance | - | ± 1 % | ± 5 % | | | |
| 4.7 | - | Voltage proof | <i>U</i> = 1.4 x <i>U</i> _{ins} ; 60 s | No flashover o | r breakdown | | | |
| 4.13 | - | Short time overload | $U = 2.5 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{max};$ duration: Acc. to style | \pm (0.25 % <i>R</i> + 0.05 Ω) | \pm (0.5 % <i>R</i> + 0.05 Ω) | | | |
| 4.17.2 | 58 (Td) | Solderability | Solder bath method; Sn60Pb40 non activated flux; $(235 \pm 5) \ ^{\circ}C$ $(2 \pm 0.2) \ ^{\circ}S$ | Good tinning (≥ 9 no visible 6 | | | | |
| 4.17.2 | 58 (TU) | Solderability | Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux; $(245 \pm 5) \ ^{\circ}C$ $(3 \pm 0.3) \ ^{\circ}S$ | Good tinning (≥ 9 no visible e | , | | | |
| 4.8.4.2 | - | Temperature coefficient | (20/- 55/20) °C and (20/125/20) °C | ± 100 ppm/K | ± 200 ppm/K | | | |
| 4.32 | 21 (Uu ₃) | Shear (adhesion) | RR 1608 and smaller: 9 N RR 2012 and larger: 45 N | No visible | damage | | | |
| 4.33 | 21 (Uu ₁) | Substrate bending | Depth 2 mm; 3 times | No visible damage, no ope ± (0.25 % <i>R</i> | • | | | |
| 4.19 | 14 (Na) | Rapid change of temperature | 30 min. at - 55 °C; 30 min. at 125 °C 5 cycles 1000 cycles | ± (0.25 % <i>R</i> + 0.05 Ω) ± (1 % <i>R</i> + 0.05 Ω) | ± (0.5 % <i>R</i> + 0.05 Ω) ± (1 % <i>R</i> + 0.05 Ω) | | | |
| 4.23 | - | Climatic sequence: | - | | | | | |
| 4.23.2 | 2 (Ba) | Dry heat | 125 °C; 16 h | | | | | |
| 4.23.3 | 30 (Db) | Damp heat, cyclic | 55 °C; ≥ 90 % RH; 24 h; 1 cycle | | | | | |
| 4.23.4 | 1 (Aa) | Cold | - 55 °C; 2 h | \pm (1 % <i>R</i> + 0.05 Ω) | ± (2 % R + 0.1 Ω) | | | |
| 4.23.5 | 13 (M) | Low air pressure | 1 kPa; (25 ± 10) °C; 1 h | | | | | |
| 4.23.6 | 30 (Db) | Damp heat, cyclic | 55 °C; ≥ 90 % RH; 24 h; 5 cycles | | | | | |
| 4.23.7 | - | DC load | $U = \sqrt{P_{70} \times R}$ | | | | | |
| 4.05.4 | | Endurance | $U = \sqrt{P_{70} \times R} \le U_{\text{max.}};$ 1.5 h on; 0.5 h off; | | | | | |
| 4.25.1 | - | at 70 °C | 70 °C; 1000 h | ± (1 % <i>R</i> + 0.05 Ω) | ± (2 % R + 0.1 Ω) | | | |
| | | | 70 °C; 8000 h | \pm (2 % <i>R</i> + 0.1 Ω) | \pm (4 % <i>R</i> + 0.1 Ω) | | | |



D/CRCW e3

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| TEST PROCEDURES AND REQUIREMENTS | | | | | | | | |
|----------------------------------|--|--|--|---|-----------------------------------|--|--|--|
| | IEC | | | REQUIREMENTS PERMISSIBLE CHANGE (△ <i>R</i>) SIZE 0402 to 2512 | | | | |
| EN 60115-1 | 60068-2 | TEST | PROCEDURE | | | | | |
| CLAUSE | TEST METHOD | | THEOLDONE | STABILITY CLASS 1 OR BETTER | STABILITY CLASS 2 OR BETTER | | | |
| | | | Stability for product types: | | | | | |
| | | | D/CRCW e3 | 1 Ω to 1 | 0 ΜΩ | | | |
| 4.18.2 | 58 (Td) | Resistance to soldering heat | Solder bath method (260 ± 5) °C; (10 ± 1) s | \pm (0.25 % <i>R</i> + 0.05 Ω) | \pm (0.5 % <i>R</i> + 0.05 Ω) | | | |
| 4.35 | - | Flamability, needle flame test | IEC 60695-11-5; 10 s | No burning | after 30 s | | | |
| 4.24 | 78 (Cab) | Damp heat, steady state | (40 ± 2) °C; (93 ± 3) % RH; 56 days | ± (1 % <i>R</i> + | · 0.05 Ω) | | | |
| 4.25.3 | - | Endurance at upper category temperature | 155 °C, 1000 h | ± (1 % <i>R</i> + 0.05 Ω) | \pm (2 % <i>R</i> + 0.1 Ω) | | | |
| 4.40 | - | Electrostatic discharge (human body model) | IEC 61340-3-1; 3 pos. + 3 neg. discharges; ESD voltage acc. to size | ± (1 % <i>R</i> + 0.05 Ω) | | | | |
| 4.29 | 45 (XA) | Component solvent resistance | Isopropyl alcohol; 50 °C; method 2 | No visible | damage | | | |
| 4.30 | 4.30 45 (XA) Solvent resistance of marking | | Isopropyl alcohol; 50 °C; method 1, toothbrush | Marking no visible | | | | |
| 4.22 | 6 (Fc) | Vibration, endurance by sweeping | $ \begin{array}{l} f = 10 \; Hz \; to \; 2000 \; Hz; \\ x, \; y, \; z \leq 1.5 \; mm; \\ A \leq 200 \; m/s^2; \\ 10 \; sweeps \; per \; axis \end{array} $ | \pm (0.25 % <i>R</i> + 0.05 Ω) | \pm (0.5 % <i>R</i> + 0.05 Ω) | | | |
| 4.37 | - | Periodic electric overload | $U = \sqrt{15 \times P_{70} \times R} \\ \le 2 \times U_{max.}; \\ 0.1 \text{ s on; } 2.5 \text{ s off;} \\ 1000 \text{ cycles} $ | ± (1 % <i>R</i> + 0.05 Ω) | | | | |
| 4.27 | - | Single pulse high voltage overload, 10 μs/700 μs | $\hat{U} = 10 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{max.};$ 10 pulses | ± (1 % <i>R</i> + 0.05 Ω) | | | | |

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x, environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3.

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